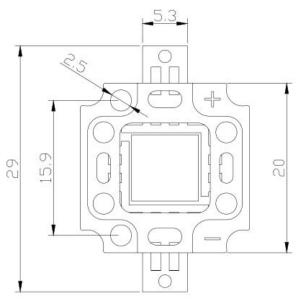


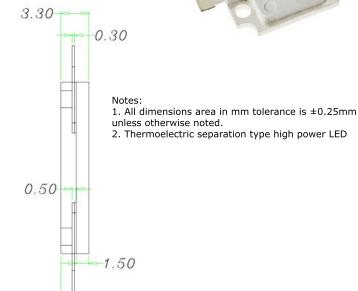
ARPL-10W White 6000K (LMA009)

Description

| Part No. | Material | Dimensions | Viewing angle |
|----------------------------------|-----------|-------------|---------------|
| ARPL-10W White 6000K (LMA009) | InGaN/GaN | 20x20x3.3mm | 120° |

Package Dimensions





Absolute Maximum Rating at Ta=25°C

| Parameter | Symbol | Maximum | Units |
|-------------------------|----------------|----------|-------|
| Forward Current | I _F | 350 | mA |
| Maximum forward current | I_{FP} | 700 | mA |
| Reverse Voltage | V _R | 5 | V |
| Power consumption | P _D | 10000 | mW |
| Operation Temperature | Topr | -40~+100 | °C |
| Storage Temperature | Tstg | -40~+100 | °C |

1.30-

Product Optical Properties at Ta=25°C

| Parameter | Symbol | Conditions | Min. | Average | Max | Units |
|-------------------|-------------------|-----------------------|------|---------|------|-------|
| Forward Voltage | VF | I _F =350mA | 28 | | 36 | V |
| Reverse current | I _R | V _R =5V | | | 10 | μA |
| Chromaticity | CCT | I _F =350mA | 5500 | | 6500 | К |
| Color coordinates | Х | I _F =350mA | | 0.33 | | |
| | Υ | I _F =350mA | | 0.33 | | |
| Luminous flux | Φ _ν | I _F =350mA | 700 | | 800 | Im |
| Half Power Angle | 2θ _{1/2} | $I_{\rm F}$ =350mA | | 120 | | deg |

Important Notes:

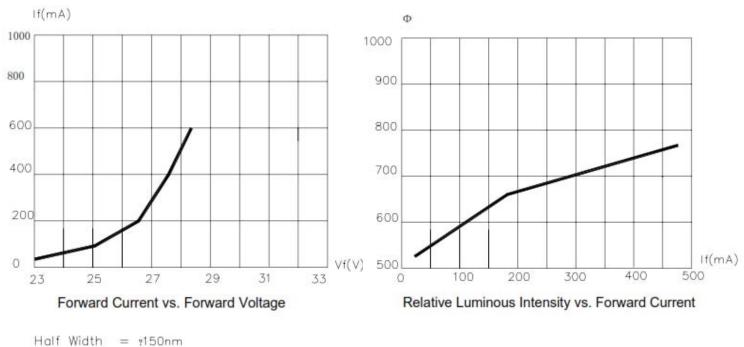
- 1) All ranks will be included per delivery rank ratio will be determined by Yusing.
- 2) Tolerance of measurement of Vf is ± 0.7 V.

Pulse width≤0.1msec duty≤1/10

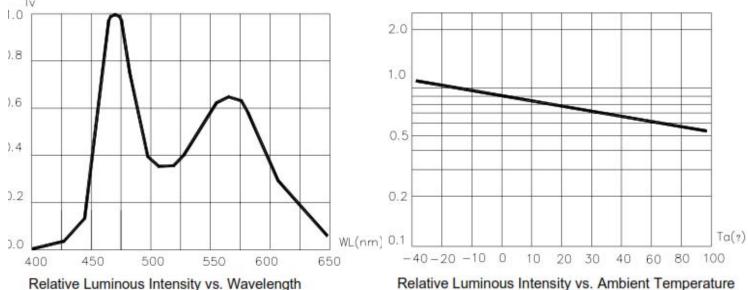
- 3) Tolerance of measurement of the color coordinates X, Y is ± 0.015 .
- 4) Tolerance of measurement of luminous intensity is $\pm 15\%$.
- 5) For how to use Yusing LED product safely, Please refer to "Application Notes" section on page 5 to 6.
- 6) As we are making continuous efforts to improve the performance of LED,
- Specifications are subject to change without notice.
- 7) Information is tentative and subject to change without notice.



Typical optical characteristics curves

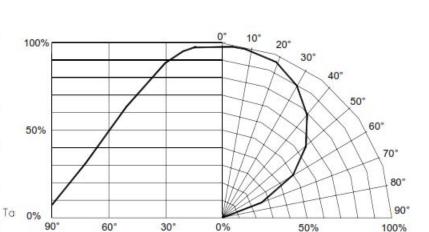






Relative Luminous Intensity vs. Wavelength

If(mA)



Relative Luminous Intensity vs.Radiation Angle

Maximum Forward Current vs. Ambient Temperature



Application Notes

Storage

- Before opening the package, the LEDs should be kept under the condition < 30°C and < 90%RH.
 After opening the package, the LEDs should be stored under the condition < 30°C and < 70%RH.
- The LEDs should be used within a year. And after opening the package, The LEDs should be used within 168 hours (7 days).
- If the desiccant is faded or the LEDs have exceeded the storage time, Re-baking is required under the condition 60±6°C for 24 hours.
- The lens of LEDs is prone to attact dust so the relevant steps should be taken to keep the emitter free of dust.

Handling

Handle the component along the side surfaces by using forceps or appropriate tools. The forceps or other appropriate tools should not put any pressure on the lens, it's also strictly forbidden to poke and press the lens.

Thermal Management

When the LED is drived by large current, the TJ (junction temperature) will exceed its limit, which will shorten the lifetime of LEDs seriously. The thermal management should effectively reduce the thermal resistance of products.

The general way for the thermal management is to mount the LED on a metal core printed circuit board(MCPCB). It is recommended that the surface area of the MCPCB is at least 30 cm² for 1W LED(and 80cm² for 3W LED), and the MCPCB material with a thermal conductivity greater than 2.0W/mK. The thermal glue or paste should with a thermal conductivety greater than 1.0W/mK and its thickness must be less than 100um.

Soldering/Reflow Soldering

Soldering Iron

It is recommended to solder by soldering iron with the soldering iron tip temperature less than 350°C and with the time less than 3 seconds. The power of soldering iron should be less than 60W After finishing one lead soldering, wait 2 seconds or more for another lead soldering. Do not press the lens while soldering, the problems often start at the time of soldering, so be careful for the soldering.

2. Reflow Soldering Conditions

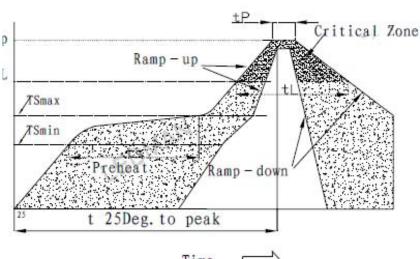




Table of Classification Reflow Profiles:

| Profile Feature | Sn-Bi Electric Assembly | Sn-Free Electric Assembly | |
|---------------------------------|-------------------------|---------------------------|--|
| Average ramp-up rate (TL to TP) | 3°C/second max. | 3℃/second max. | |
| Preheat | 60-120seconds | 60-180seconds | |
| -Temperature Min.(Tsmin) | 100°C | 150°C | |
| -Temperature Min.(Tsmax) | 130℃ | 200℃ | |
| Tsmax to TL | 100 | | |
| -Ramp-up Rate | 3°C/second | 3°C/second | |
| Time maintained aboveTL | 160°C/60-150seconds | 210°C/60-150seconds | |
| Peak Temperature(TP) | 190+0/-5℃ | 250+0/-5℃ | |
| Time within 5°C of Actual Peak | 10 seconds | 10 seconds | |
| Temperture(TP) | | · | |
| Ramp-down Rate | 6°C/Seconds max. | 6℃/Seconds max. | |
| Time 25℃ to Peak Temperture | 6 minutes max. | 8 minutes max. | |

Notes:

- (a)Reflow soldering should not be done more than two times.
- (b)While soldering, do not put stress on the LEDs during heating.
- (c)After soldering, do not warp the circuit board

Cleaning

When cleaning is necessary, using the clean soft cloth and dipping the isopropyl alcoho to erasure the dirt gently. Do not clean it with the solvents such as Acetone, lest erode or destroy the LEDs.

Electrical Notes

- The LED can not be drived reversely.
- It's necessary to have the measures to limit the current Otherwise slight voltage shift may cause enormous current change and results in the failure of LEDs.
- It is recommended that the drive current should be lower when the light output is enough for applying. It would be helpful to improve the product's reliability.

Antistatic

The LEDs are electrostatic sensitive devices, so antistatic steps should be taken during the processing.